#### TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

# 2 S C 5 3 2 4

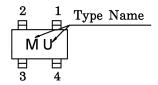
# VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

Low Noise Figure : NF = 1.4dB (f = 2GHz) $: |S_{21e}|^2 = 12dB (f = 2GHz)$ High Gain

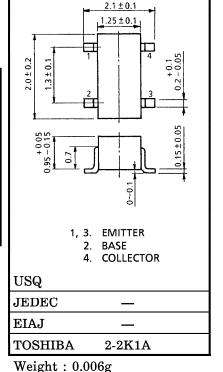
#### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$v_{CBO}$	8	V
Collector-Emitter Voltage	$V_{CEO}$	5	V
Emitter-Base Voltage	$v_{EBO}$	1.5	V
Collector Current	$I_{\mathbf{C}}$	10	mA
Base Current	I <sub>B</sub>	5	mA
Collector Power Dissipation	PC	100	mW
Junction Temperature	Tj	125	$^{\circ}\mathrm{C}$
Storage Temperature Range	$T_{ m stg}$	-55~125	$^{\circ}\mathrm{C}$

## Marking



#### Unit in mm



# MICROWAVE CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transition Frequency	$\mathbf{f_{T}}$	$V_{CE}=3V$ , $I_{C}=7mA$	13	16	_	GHz
Insertion (fair	$ S_{21e} ^2(1)$	$V_{CE}=3V$ , $I_{C}=7mA$ , $f=1GHz$	14.5	17.5	_	dB
	$ S_{21e} ^2$ (2)	$V_{CE}=3V$ , $I_{C}=7mA$ , $f=2GHz$	9	12	—	
Noise Figure	NF (1)	$V_{CE}=3V$ , $I_{C}=3mA$ , $f=1GHz$	_	0.9	1.8	dB
	NF (2)	$V_{CE}$ =3V, $I_{C}$ =3mA, $f$ =2GHz	_	1.4	2.3	

## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{CBO}$	$V_{CB} = 10V, I_{E} = 0$	_	_	1	μA
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB}=1V, I_{C}=0$	_	_	1	$\mu$ A
DC Current Gain	$h_{ ext{FE}}$	$V_{CE}=3V, I_{C}=7mA$	50	_	250	V
Output Capacitance	$C_{ m ob}$	$V_{CB} = 2.5V, I_{E} = 0, f = 1MHz$	_	0.35	_	рF
Reverse Transfer Capacitance	$\mathrm{c}_{\mathrm{re}}$	(Note)		0.3	_	pF

(Note) :  $C_{\mbox{re}}$  is measured by 3 terminal method with Capacitance Bridge.

This device electrostatic sensitivity. Please handle with caution.

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